Shielded Power Inductors – XFL5030

- Exceptionally low DCR – only 2.15 mOhms
- Excellent current handling – up to 11.5 A
- AEC-Q200 Grade 1 (−40°C to +125°C)
- 3.1 mm maximum height with a 5.48 mm × 5.28 mm footprint

Core material Composite
Terminations RoHS compliant tin-silver over copper. Other terminations available at additional cost.
Weight 0.42 – 0.50 g
Ambient temperature −40°C to +125°C with (40°C rise) I rms current.
Operating voltage 0 – 20 V
Maximum part temperature +165°C (ambient + temp rise). Derating.
Storage temperature Component: −55°C to +165°C.
Tape and reel packaging: −55°C to +80°C
Resistance to soldering heat Max three 40 second refloows at +260°C, parts cooled to room temperature between cycles
Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)
Packaging 400/7″ reel; 1500/13″ reel Plastic tape: 16 mm wide, 0.3 mm thick, 12 mm pocket spacing, 3.18 mm pocket depth
PCB washing Tested to MIL-STD-202 Method 215 plus an additional aqueous wash. See Doc 787_PCB_Washing.pdf.

<table>
<thead>
<tr>
<th>Part number¹</th>
<th>Inductance² ≤20% (µH) typ</th>
<th>DCR (mOhms)³</th>
<th>SRF typ⁴ (MHz)</th>
<th>Isat (A)³ 10% drop</th>
<th>20% drop</th>
<th>30% drop</th>
<th>I rms (A)³</th>
<th>20°C rise</th>
<th>40°C rise</th>
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</thead>
<tbody>
<tr>
<td>XFL5030-271ME_</td>
<td>0.27</td>
<td>2.15</td>
<td>2.55</td>
<td>132</td>
<td>10.0</td>
<td>11.0</td>
<td>11.5</td>
<td>18.0</td>
<td>25.5</td>
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<tr>
<td>XFL5030-561ME_</td>
<td>0.56</td>
<td>3.20</td>
<td>3.80</td>
<td>77.0</td>
<td>7.5</td>
<td>8.5</td>
<td>9.0</td>
<td>14.6</td>
<td>21.0</td>
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<tr>
<td>XFL5030-102ME_</td>
<td>1.0</td>
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<td>5.00</td>
<td>60.0</td>
<td>5.4</td>
<td>6.2</td>
<td>6.5</td>
<td>13.0</td>
<td>18.0</td>
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<tr>
<td>XFL5030-222ME_</td>
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<td>12.0</td>
<td>37.4</td>
<td>3.5</td>
<td>4.0</td>
<td>4.3</td>
<td>8.2</td>
<td>11.5</td>
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<tr>
<td>XFL5030-332ME_</td>
<td>3.3</td>
<td>13.5</td>
<td>16.0</td>
<td>28.7</td>
<td>3.1</td>
<td>4.0</td>
<td>4.2</td>
<td>7.2</td>
<td>10.0</td>
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<tr>
<td>XFL5030-472ME_</td>
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<td>18.5</td>
<td>22.0</td>
<td>24.5</td>
<td>2.5</td>
<td>3.1</td>
<td>3.3</td>
<td>6.2</td>
<td>8.7</td>
</tr>
</tbody>
</table>

1. When ordering, please specify packaging code:

   XFL5030-472ME
   Packaging: C = 7″ machine-ready reel, EIA-481 embossed plastic tape (400 parts per full reel). Quantities less than full reel available: in tape (not machine ready) or with leader and trailer ($25 charge).
   B = Less than full reel. In an effort to simplify our part numbering system, Coilcraft is eliminating the need for multiple packaging codes. When ordering, simply change the last letter of your part number from B to C.
   D = 13″ machine-ready reel. EIA-481 embossed plastic tape. Factory order only, not stocked (1500 parts per full reel).

2. Inductance tested at 1 MHz, 0.1 Vrms, 0 Adc.
3. DCR measured on a micro-ohmmeter.
4. SRF measured using Agilent/HP 4395A or equivalent.
5. DC current at 25°C that causes an inductance drop of 30% (typ) from its value without current. Click for temperature derating information.
6. Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings. Click for temperature derating information.
7. Electrical specifications at 25°C.

Refer to Doc 362 “Soldering Surface Mount Components” before soldering.

I rms Testing
I rms testing was performed on 0.75 inch wide × 0.25 inch thick copper traces in still air.
Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

Click for temperature derating information.
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L vs Current

- Inductance (µH) vs Current (A)
  - 0.27 µH at Current = 0.1 A
  - 0.56 µH at Current = 12 A

L vs Frequency

- Inductance (µH) vs Frequency (MHz)
  - 4.7 µH at Frequency = 4 MHz
  - 3.3 µH at Frequency = 3 MHz
  - 2.2 µH at Frequency = 2 MHz
  - 1.0 µH at Frequency = 1 MHz
  - 0.56 µH at Frequency = 0.5 MHz
  - 0.27 µH at Frequency = 0.1 MHz

Dash number indicates direction of terminals and start (short) lead. Connect high dv/dt here for lowest EMI.

Recommended Land Pattern

Dimensions are in inches / mm.

For optional tin-lead and tin-silver-copper terminations, dimensions are for the mounted part. Dimensions before mounting can be an additional 0.005 inch / 0.13 mm.

*For optional tin-lead and tin-silver-copper terminations, dimensions are for the mounted part. Dimensions before mounting can be an additional 0.005 inch / 0.13 mm.

Inductance (µH) vs Frequency

- 0.208 ±0.008
- 5.28 ±0.2
- 0.216 ±0.008
- 5.48 ±0.2

Dimensions are in inches / mm.

* For optional tin-lead and tin-silver-copper terminations, dimensions are for the mounted part. Dimensions before mounting can be an additional 0.005 inch / 0.13 mm.

- 0.122 mm max
- 0.165 mm typ

Dimensions are in inches / mm.

- 0.130 mm
- 3.3 mm
- 0.185 mm
- 4.7 mm
- 0.046 mm
- 1.15 mm

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